

Important notice

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Kind regards,

Team Nexperia



SOT163-1

Tape reel SMD; standard product orientation 12NC ending 115

Rev. 1 — 25 April 2013

Packing information

1. Packing method

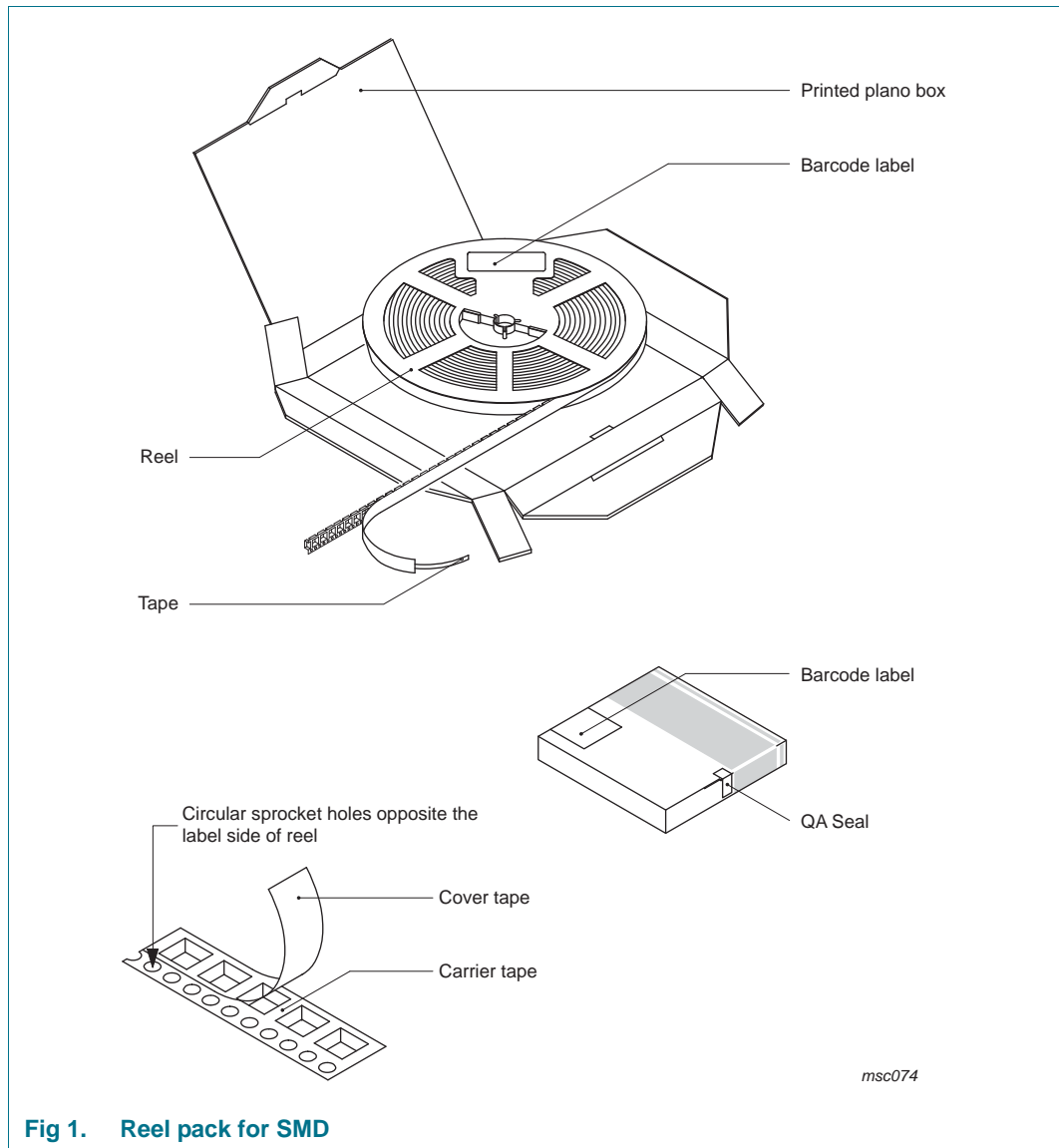


Table 1. Packing information

Package version	12NC ending	Reel dimensions d x w (mm) ^[1]	SPQ/PQ (pcs)	Reels per box	Outer box dimensions l x w x h (mm)
SOT163-1	115	180 x 24	500	1	190 x 190 x 38

[1] d = reel diameter; w = tape width.



2. Product orientation

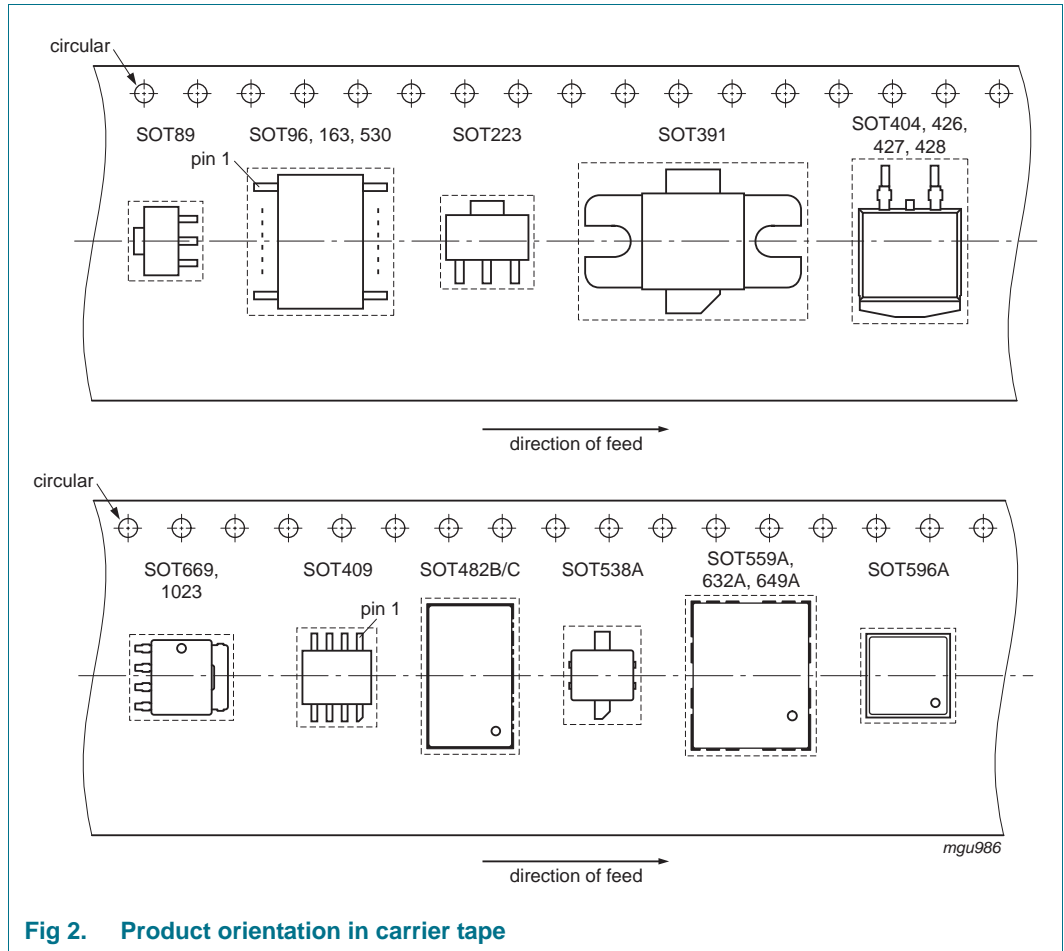


Fig 2. Product orientation in carrier tape

3. Carrier tape dimensions

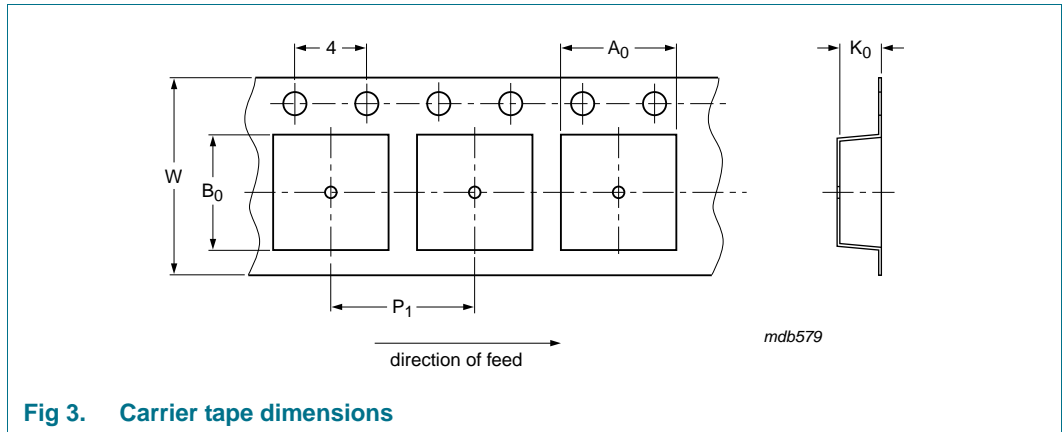


Fig 3. Carrier tape dimensions

Table 2. Carrier tape dimensions

In accordance with IEC 60286-3.

A_0 (mm)	B_0 (mm)	K_0 (mm)	T (mm)	P_1 (mm)	W (mm)
11.1	13.5	2.7	-	12.0	24

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